# History of Computers

## Third Generation: Integrated Circuits

- 1958 the invention of the integrated circuit
- Discrete component
  - Single, self-contained transistor
  - Manufactured separately, packaged in their own containers, and soldered or wired together onto masonite-like circuit boards
  - Manufacturing process was expensive and cumbersome
- The two most important members of the third generation were the IBM System/360 and the DEC PDP-8



#### +

## Microelectronics

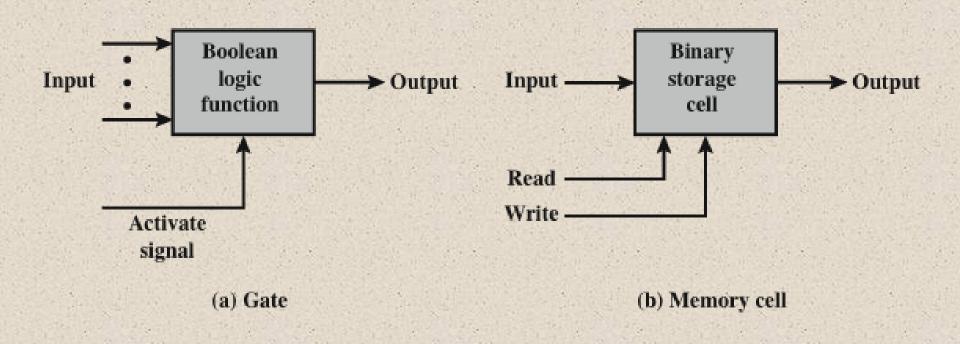


Figure 2.6 Fundamental Computer Elements

# Integrated Circuits

- Data storage provided by memory cells
- Data processing provided by gates
- Data movement the paths among components are used to move data from memory to memory and from memory through gates to memory
- Control the paths among components can carry control signals

- A computer consists of gates, memory cells, and interconnections among these elements
- The gates and memory cells are constructed of simple digital electronic components
- Exploits the fact that such components as transistors, resistors, and conductors can be fabricated from a semiconductor such as silicon
- Many transistors can be produced at the same time on a single wafer of silicon
- Transistors can be connected with a processor metallization to form circuits

Wafer,
Chip,
and
Gate
Relationship

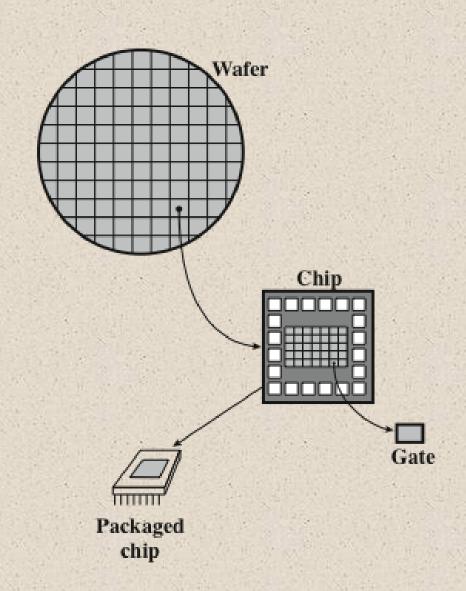


Figure 2.7 Relationship Among Wafer, Chip, and Gate

## Chip Growth

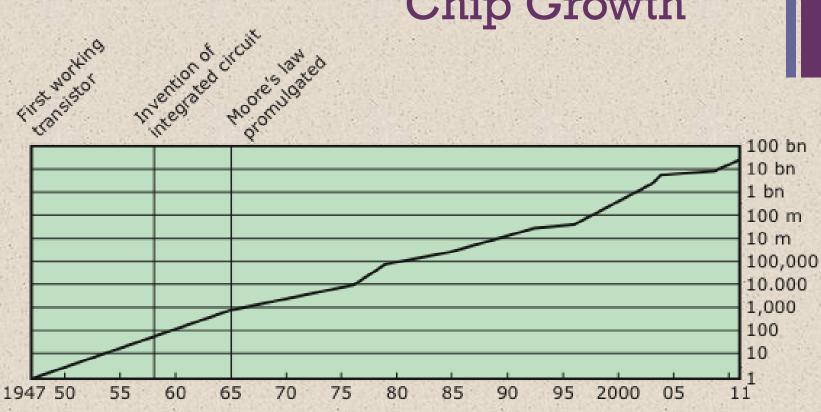


Figure 2.8 Growth in Transistor Count on Integrated Circuits (DRAM memory)

#### Moore's Law

#### 1965; Gordon Moore – co-founder of Intel

Observed number of transistors that could be put on a single chip was doubling every year

The pace slowed to a doubling every 18 months in the 1970's but has sustained that rate ever since

#### Consequences of Moore's law:

The cost of computer logic and memory circuitry has fallen at a dramatic rate

The electrical path length is shortened, increasing operating speed

Computer
becomes
smaller and is
more
convenient to
use in a variety
of
environments

Reduction in power and cooling requirements

Fewer interchip connections

# IBM System/360

- **1964**
- Replaced (& not compatible with) 7000 series
- First planned "family" of computers
- Similar or identical instruction sets
- Similar or identical O/S
- Increasing speed
- Increasing number of I/O ports (i.e. more terminals)
- Increased memory size
- Increased cost
- Multiplexed switch structure

# + IBM System/360



# Table 2.4 Characteristics of the System/360 Family

Characteristic	Model 30	Model 40	Model 50	Model 65	Model 75
Maximum memory size (bytes)	64K	256K	256K	512K	512K
Data rate from memory (Mbytes/sec)	0.5	0.8	2.0	8.0	16.0
Processor cycle time μs)	1.0	0.625	0.5	0.25	0.2
Relative speed	1	3.5	10	21	50
Maximum number of data channels	3	3	4	6	6
Maximum data rate on one channel (Kbytes/s)	250	400	800	1250	1250

Table 2.4 Characteristics of the System/360 Family

## DEC PDP-8

- **1964**
- First minicomputer (after miniskirt!)
- Did not need air conditioned room
- Small enough to sit on a lab bench
- **\$16,000**
- \$100k+ for IBM 360
- Embedded applications & OEM
- BUS STRUCTURE

+ DEC PDP-8



# Table 2.5 Evolution of the PDP-8

		Cost of Processor +	Data Rate from		
	First	4K 12-bit Words of	Memory	Volume (cubic	Innovations and
Model	Shipped	Memory (\$1000s)	(words/µsec)	feet)	Improvements
PDP-8	4/65	16.2	1.26	8.0	Automatic wire-
					wrapping production
PDP-8/5	9/66	8.79	0.08	3.2	Serial instruction
					implementation
PDP-8/1	4/68	11.6	1.34	8.0	Medium scale
					integrated circuits
PDP-8/L	11/68	7.0	1.26	2.0	Smaller cabinet
PDP-8/E	3/71	4.99	1.52	2.2	Omnibus
PDP-8/M	6/72	3.69	1.52	1.8	Half-size cabinet with
					fewer slots than 8/E
PDP-8/A	1/75	2.6	1.34	1.2	Semiconductor
					memory; floating-point
					processor

Table 2.5 Evolution of the PDP-8

# DEC - PDP-8 Bus Structure

- IBM used the central-switched
- architecture on its 700/7000 and 360
- systems.
- PDP-8 used a structure that is now
- virtually universal formicrocomputers: The bus structure.
- The PDP-8 bus, called the Omnibus, consists of 96 separate signal paths,
- used to carry control, address, and data signals.

## DEC - PDP-8 Bus Structure

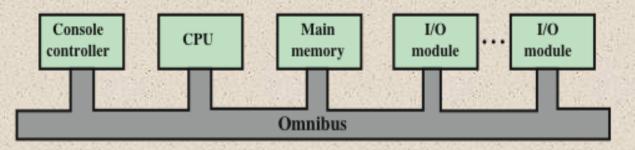


Figure 2.9 PDP-8 Bus Structure

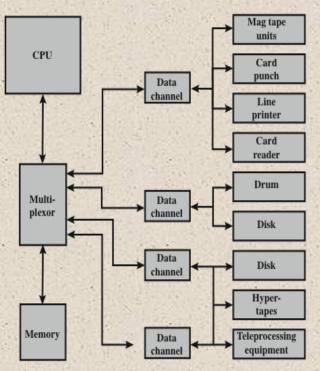


Figure 2.5 An IBM 7094 Configuration